Picosecond Timing Resolution Measurements of Low Gain Avalanche Detectors with a 120 GeV Proton Beam for the TOPSiDE Detector Concept

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Abstract

This paper presents results that take a critical step toward proving 10 ps timing resolution's feasibility for particle identification in the TOPSiDE detector concept for the Electron-Ion Collider. Measurements of LGADs with a thickness of 35 μ m and 50 μ m are evaluated with a 120 GeV proton beam. The performance of the gain and timing response is assessed, including the dependence on the reverse bias voltage and operating temperature. The best timing resolution of UFSDs in a test beam to date is achieved using three combined planes of 35 μ m thick LGADs at -30 °C with a precision of 14.31 \pm 1.52 ps.

Keywords: Silicon, Charge Multiplication, Thin sensors, Ultra-Fast Silicon Detectors, Low-Gain Avalanche Detectors

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1. Introduction

Ultra-Fast Silicon Detectors (UFSD) [1] are a novel type of silicon detector that simultaneously provides spatial and timing resolution. One kind of UFSD, the Low-Gain Avalanche Detector (LGAD) [2], relies on an internal charge multiplication mechanism, or an avalanche effect, that is introduced in a controlled manner by the implantation of an appropriate acceptor or donor dopant layer. The internal charge multiplication process provides a moderate internal gain that increases the detector signal output, which further increases the signal-to-noise (S/N) ratio [3].

UFSDs are targeted at a range of new opportunities from space science, mass spectroscopy, medical science to nuclear and particle physics [4]. The precision timing measurement combined with the high granularity spatial measurement enables a 4-Dimensional detector concept for particle detectors. A precise timing response translates into excellent time-of-flight (ToF) measurements, thus providing good particle identification (PID). The Timing Optimized PID Silicon Detector (TOPSiDE) concept [5–7] for the Electron-Ion Collider (EIC) is one such application that implements a 4D concept requiring precision timing on the order of 10 ps. With such precision, pion/kaon separation up to 7 GeV/c is expected using the ToF method with the efficiency of 90% [8]. It provides the precision measurements required for the EIC's broad physics program; some major topics include deep inelastic structure functions of protons and nuclei, spin structure functions, generalized parton distributions (GPDs), and transverse momentum dependent distributions (TMDs) [9]. Here, the results demonstrate a 15 ps timing resolution with three layers of 35 μ m thick sensors. It is expected that with thinner sensors, the 10 ps goal is readily achievable.

2. Low Gain Avalanche Detectors

LGADs are distinguished from traditional silicon sensors by the gain layer beneath the electrode contacts, as shown in figure 1. The charge carrier collection time inside the silicon is limited by saturation of electron drift velocity at about 10^7 cm/s and takes ~ 1 ns to collect the charge for a ~ 100 μ m thick sensor [1, 10]. The thicker sensors are required to keep the S/N to a level acceptable to the electronics. An LGAD relies on a gain layer to increase the signal by a factor of 10 to 100, allowing thinner sensors and a shorter drift distance with shorter collection time [1, 10].

The first LGAD was fabricated by Centro Nacional de Microelectrónica (CNM-IMB), Barcelona, Spain, with a thickness of 300 μ m and maximum gain of 10 at a bias voltage of 300 V at -10 °C [2]. The timing resolution of the order of 100 ps is reported for these sensors [11, 12]. Since then, several LGADs with much thinner thickness and improved gain have been studied [11, 13]. The best timing precision recorded so far with a single UFSD under test is 18 ps for LGAD with a thickness of 50 μ m and the gain of ~70 at -20 °C [14]. The paper [15] also reported the timing resolution of 17 \pm 1 ps for the trigger sensor. The best timing precision measured in a test beam scenario is 27 ps with a single LGAD sensor with thickness 45 μ m (gain 70) [3] and 50 μ m (gain 27) [16] at 180 GeV pion beam at CERN. The best timing reported with three 45 μ m LGADs together in test beam set-up is 16 ps [3].

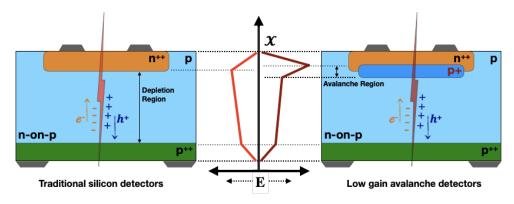


Figure 1: Traditional silicon detector (left) and low-gain avalanche detector (right).

3. Experimental setup

Measurements of several types of LGADs are performed with a 120 GeV proton beam at the Fermilab Test Beam Facility (FTBF). The trigger sensor's timing resolution is measured using 90 Sr β -telescope setup in the laboratory. The UFSD devices are characterized for charge collection efficiency, gain, and timing resolution for different bias voltages and temperatures. The following subsections describe the samples and test setup.

3.1. LGAD Devices and Electrical properties

The LGADs with different thicknesses, doping concentrations, and sensor types (pad, pixels, strips, AC-LGADs) have been measured for timing res-

olution and radiation hardness. The LGADs tested and presented in this paper are manufactured by Hamamatsu Photonics K.K. (HPK) and tagged as HPK-1.2 and HPK-3.1. The sensors are n-on-p type with a thickness of 35 μ m and 50 μ m, respectively, whereas the physical thickness, including substrate wafer, varies between 300 to 350 μ m. HPK1.2 and HPK3.1 both have an active pad area of 1.3×1.3 mm². Both the LGADs are doped with Boron to create an internal multiplication layer. HPK-1.2 has shallow implantation, and higher resistivity with a breakdown voltage of around 270 V at room temperature. The HPK-3.1 has deeper implantation with a breakdown voltage slightly above 245 V at room temperature. The capacitance of the LGADs vary with the total active bulk and doping profile. It is measured to be 5.35 pF and 3.9 pF for LGADs HPK-1.2 and HPK-3.1, respectively. The detailed description of the LGADs can be found in references [17–20].

Table 1: The description of LGAD devices under test.

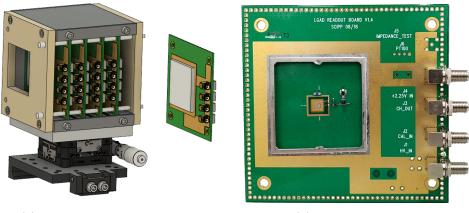
Sensors HPK	Type	Thickness (μm)	Pad Area (mm ²)	C (pF)	Rise Time (10-90%)	Breakdown Voltage
3.1	n-on-p	50	1.3×1.3	3.9	470 ps	245 V
1.2	n-on- p	35	1.3×1.3	5.35	375 ps	270 V

Additionally, an HPK8664, a p-on-n type LGAD sensor, is evaluated. The HPK8664 has a round pad with a circular area of about 1 mm² without any guard ring protection. With the breakdown voltage of 430 V, this sensor is used as a trigger during data taking.

3.2. Sample Setup

The LGAD sensors were mounted on a $\sim 10 \times 10$ cm² read-out board, shown in figure 2(b). The single-channel read-out board contains wide bandwidth (\sim 2 GHz) and low noise inverting amplifier with a gain of 10 and has been used in previous studies[1, 3]. The inverting amplifier is followed by a second stage 2 GHz external amplifier with a gain of 10. The combined transimpedance of the read-out is about 4700 Ω .

The sensors are glued to the 5 mm square pad on the read-out board, and the guard ring is grounded. Two or more read-out boards are aligned backto-back, as shown in the figure 2(a) using alignment rods passing through



(a) UFSD alignment set-up.

(b) Read-out board.

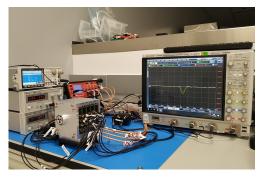
Figure 2: The alignment frame (left) and read-out front-end board with discrete components to collect the signal (right).

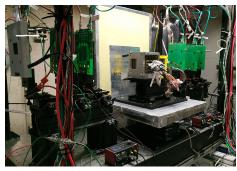
the holes at each corner of the alignment frame and read-out boards. The alignment box is designed to use up to four sample boards. It is used in both setups, the 90 Sr β -Telescope and test beam measurement setup as shown in the figure 3(a) and 3(b) respectively. In the 90 Sr β -Telescope it has a source holder aligned with LGAD positions on the read-out board. Whereas, for test beam measurements, the Aluminum plates have an open window to pass the beam and prevent the absorption/energy loss of the incoming particles. The incident particle radiations pass perpendicularly through the sample boards and the sensors' active region in each case.

In each case, one sensor is designated as the trigger sensor (TRG), and the other sensors are considered as the devices under test (DUTs). The samples are biased using CAEN DT1471ET high voltage supply. The amplified signal from the read-out is recorded using a 2.2 GHz Keysight DSOS204A digital oscilloscope. The sampling rate is 20 GSa/s with a time discretization of 50 ps with two active channels. In contrast, the sampling rate reduces to 10 GSa/s with a time discretization of 100 ps while using all four oscilloscope channels. The events are registered from all DUTs when the trigger sensor provides a signal above the threshold value. The oscilloscope captures the events as a signal pulse waveform. The raw data is acquired and stored in a computer using a Python-based PyVisa interface, referred to as the DAQ framework.

3.3. $^{90}Sr \beta$ -Telescope Setup

The 90 Sr β -source measurements are performed by mounting the source in the alignment box. The β particle can only penetrate two sensors before being absorbed. Thus, only two oscilloscope channels are used, allowing for a 20 GSa/s sampling rate. Cold measurements are done by placing the setup in an environmental chamber.





- (a) On bench setup in the lab.
- (b) Test beam setup at Fermi Lab.

Figure 3: Test setup for timing measurements of LGADs using time-of-flight (TOF) technique for minimum ionizing particles (MIP) using Sr⁹⁰ source in the lab (left) and at the Fermi lab test beam facility (right).

3.4. Fermilab Test Beam Setup

The test beam measurements are performed at the Fermilab Test Beam Facility (FTBF) using a 120 GeV proton beam [21]. For the test beam campaign, four LGAD sensors are used simultaneously, utilizing all four oscilloscope channels. However, this limits the sampling rate to 10 GSa/s with a time discretization of 100 ps. The time resolution measurements are compared to those with a sampling rate of 20 GSa/s, and the results are consistent. The trigger sensor is the fourth LGAD sensor in the alignment box placed downstream in the beamline. The data is acquired at room temperature for two types of UFSDs as described above. Additionally, the low-temperature measurements are performed for the HPK-1.2 at -30 °C. The temperature reported in this paper is the temperature of the air inside the cold enclosure where the measurement system is housed. It is maintained at a low temperature using a cold plate cooled by a Julabo FP89-ME recirculating chiller. The humidity inside the box is kept below the dew point by using Nitrogen purging.

The test beam data is collected in spills of 4 seconds per minute. The symmetric beam profile with σ -value of 2-4 mm is used, and intensity is maintained between 100K to 200K protons every spill. The beam is adjusted to get an instantaneous trigger rate between 1 and 10 Hz. All the DUTs in the setup are operated at the same bias voltage in each run. The data is acquired at biases ranging from 200 V to 255 V for UFSDs; HPK-1.2, and HPK-3.1 at different temperature conditions. The maximum bias voltage is defined by the breakdown conditions for a particular UFSD at a specific temperature. The trigger is supplied with a fixed bias voltage of 425 V throughout the test beam run. The leakage current through all the sensors was stable at around 15-25 nA during the test run.

Figure 4 shows an example of one of the events at a test beam run where all four UFSDs are fired. In the event, all four HPK-1.2 UFSDs are operated at a bias voltage of 250 V with a leading-edge time around 350 ps.

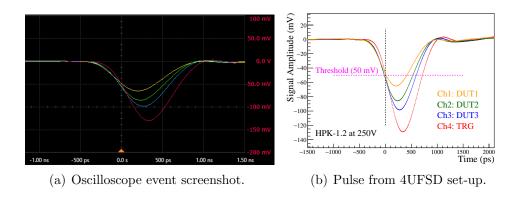


Figure 4: The event with a signal pulse from TRG and DUT. As detectors are aligned back-to-back, such events are considered to be from minimum ionizing particles (MIP).

4. Data Analysis Method

The data analysis follows a similar procedure as [3, 15]. It uses only those variables which would be available with a hypothetical read-out chip, like time-of-arrival (ToA), signal amplitude, and time-over-threshold (ToT). The time at which the signal pulse crosses a certain fraction of the maximum signal amplitude is considered time-of-arrival. The corresponding amplitude is referred to as the CFD value. For example, cfd[20] indicates the time with

CFD value equals to 20% of maximum pulse amplitude. The information plays a critical role in calculating different parameters, like the time difference between DUT and trigger, rise time, jitter, etc. The method is called a constant fraction discriminator (CFD) method. The CFD method is highly effective in correcting the time-walk effect by overcoming the limitation imposed by the oscilloscope digitization. Figure 5(a) shows the calculation of CFD value and the corresponding time using a linear interpolation method. The distribution of time at different CFD values (fractions) and its comparison with signal waveform data is shown in figure 5(b).

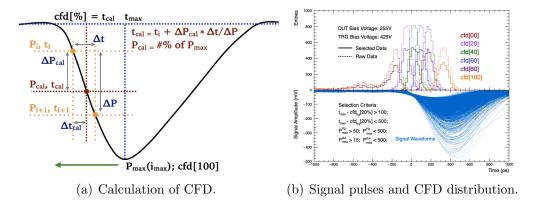


Figure 5: The CFD value calculation using the linear interpolation method provides the timing information at a certain fraction of maximum signal amplitude (left). The time distribution at different CFD values compared to signal waveform data for the HPK-8664 trigger detector at bias voltage 425V taken with 120 GeV Proton beam (right).

The selection criteria applied to events with a valid trigger pulse are mainly based on signal amplitude and time of arrival. The maximum signal amplitude, P_{max} of all UFSDs, should be at least five times larger than the noise level, and the oscilloscope or the read-out chain should not saturate it. The second selection is on the time difference between the DUT and the trigger. The time difference criterion reduces the contribution from the non-gain events or noise. As shown in the upper panel of figure 5(b), the selection rules allow removing the low-gain tail effect on the distribution's left side. The figure 6 shows the amplitude selection along the horizontal axis and time selection along the vertical axis.

The selected data is analyzed to study the signal amplitude distribution, collected charge, the gain, the jitter, the rise time, and the timing resolution. The following sub-sections provide analysis details of these variables.

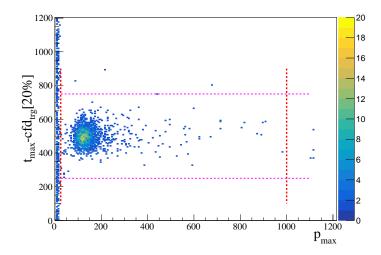


Figure 6: Event selection based on the distribution of time difference versus signal amplitude for DUT HPK-1.2 operated at bias voltage 250V with 120 GeV proton beam at Fermilab test beam facility.

4.1. Time Resolution

The time resolution, σ_t of the detector system can be expressed as a sum of different contributions [1, 22],

$$\sigma_t^2 = \sigma_{Jitter}^2 + \sigma_{LandauNoise}^2 + \sigma_{TimeWalk}^2 + \sigma_{Distortion}^2 + \sigma_{TDC}^2.$$
 (1)

The CFD method is useful in compensating for the effect of the time-walk. The signal distortion is negligible in silicon for the saturated drift velocity and uniform weighting field. It is achievable using "parallel plate" geometry with a large active area compared to sensor thickness [1]. The contribution from the time-to-digital converter (TDC) is equal to the timing uncertainty, $\Delta T/\sqrt{2}$. Where ΔT is the least significant bit of TDC. The TDC effect is minimal in most of the cases and ignored in this paper. The predominant contribution to the timing resolution is from Jitter and Landau Noise.

The Gaussian function is used to fit the time difference (Δt) distribution between the DUT and the trigger. The fitting parameter; $\sigma_{(DUT-TRG)}$ provides the timing resolution of the device under test using a quadrature.

$$\sigma_{DUT}^2 + \sigma_{TRG}^2 = \sigma_{(DUT-TRG)}^2. \tag{2}$$

The DUT and the trigger's timing resolution is denoted as σ_{DUT} and σ_{TRG} respectively. For a unique setup where DUT and TRG are the same

types of LGADs, the equation will be simplified as,

$$\sigma_{DUT} = \sigma_{(TRG-DUT)}/\sqrt{2}.$$
 (3)

4.2. Charge Collected and Gain

The energy deposited by the minimum ionizing particles in the active bulk of the LGAD sensor follows the Landau distribution before getting amplified by the internal gain process.

The ratio of total charge after multiplication and the initial number of charge carriers gives the internal gain. The collected charge is calculated by dividing the pulse area by the input trans-impedance of the detector system. The pulse area is the integration of pulse waveform from 1 ns before the start of the pulse (i.e., zero-crossing) and 3ns after the pulse reaches its maximum amplitude (i.e., t_{max}). The Weight-Field2 simulation calculates the initial charge collection using an identical PIN sensor without a gain layer.

4.3. Jitter and Landau Fluctuation

Jitter is directly proportional to the noise and minimized by having a higher slew-rate and low intrinsic noise.

$$\sigma_{jitter} = \frac{Noise}{\mathrm{d}V/\mathrm{d}t}.\tag{4}$$

Wherein, the noise is determined as the RMS fluctuation of the oscilloscope's baseline trace and calculated using $1/4^{th}$ of total points in the waveform from the beginning of the pulse.

Another contribution to timing performance is Landau noise, which is introduced by a particles' non-uniform charge deposition along its passage. The Landau noise is insensitive to the gain value and found to be dependent on CFD settings. The Landau noise decreases with the thickness of the sensor [1, 23]. It has been observed that jitter and Landau noise contribute almost equally in time resolution for sensors with a thickness below 150 μ m [1].

5. Laboratory Results

The goal is to find the timing resolution of HPK-8664, a trigger detector for the test beam campaign. The timing resolution of HPK-1.2 is measured using two identical LGADs. Figure 7(a) shows the timing difference at 50%

CFD fractions, and the timing resolution is calculated using equation 3. The HPK-1.2 provides a timing resolution of 29.03 ± 0.41 ps at bias voltage 250 V. The timing resolution of HPK-8664 is then measured using HPK-1.2 as a trigger. The HPK-8664 is operated at a bias voltage of 425 V and HPK-1.2 at 250 V. For the set-up with two different types of UFSDs, the time difference is taken at two different but optimized values of CFD fractions, i.e., 20% CFD for HPK-8664 and 50% CFD for HPK-1.2 sensor. The timing resolutions of HPK8664 is calculated using equation 2. It is 27.39 ± 0.61 ps for bias voltage 425 V at room temperature. Whereas, at temperature -30 °C, it is 24.22 ± 0.75 ps when operated at bias voltage 390 V.

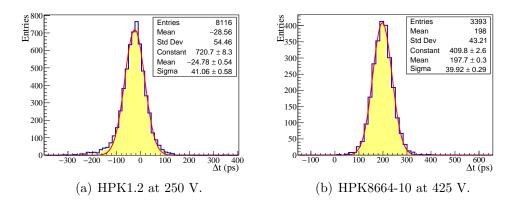


Figure 7: The distribution of time difference between the DUT and the trigger. The DUT and the trigger both are HPK-1.2 operated at $250~\rm V$ (left). The time difference between HPK-8664 at $425~\rm V$ and HPK-1.2 at $250~\rm V$ (right).

6. Test Beam Results

6.1. Charge Collection and Gain

The charge collection performance of UFSDs as a function of the bias voltage is shown in the left panel of figure 8. The rising trend indicates the increased rate of charge multiplication along with bias voltage. It also demonstrates that the charge multiplication rate increases with reduced temperature but also restricted by reduced breakdown voltage at low temperature. The right panel of figure 8 shows the gain as a function of bias voltage for HPK-1.2 and HPK-3.1. The simulated initial charge collection is 0.344 fC and 0.528 fC for 35 μ m and 50 μ m thick identical PIN sensor respectively. The results

show the exponential dependence of internal gain on the electric field and subsequently on the reverse bias voltage as expected in [1, 24]. At room temperature, the maximum gain of 76 is achieved from HPK-1.2 biased at 255 V.

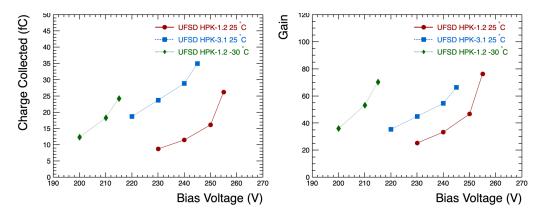


Figure 8: The charge collected (left) and the gain (right) as a function of bias voltage.

6.2. Signal Amplitude

In general, the energy deposited in the thin silicon sensor follows the Landau distribution. The average signal shape at a different internal gain is shown in the left panel of figure 9.

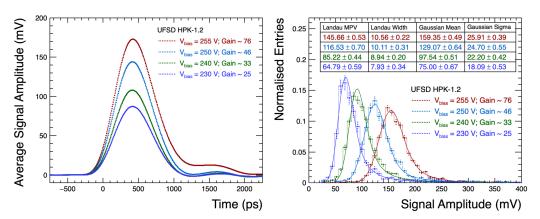


Figure 9: The average signal shape (left) and distribution of signal amplitude normalized by its integral (right).

However, the distribution of signal amplitude shown in the right panel of figure 9 exhibits the convolution of Landau and Gaussian distribution. The studies performed with laser pulse imply that the Gaussian contribution is from the read-out board's impulse response [3]. The Landau distribution provides the most probable value (MPV) and Full Width Half Maximum (FWHM). Whereas, Gaussian width, σ_{Gauss} demonstrate the noise and fluctuations. The increase in the Gaussian width with bias voltage implies an increased contribution by noise from the amplifier and the sensor's shot noise. Figure 10 shows the increasing trend of signal amplitude as a function of bias voltage for HPK-1.2 and HPK-3.1.

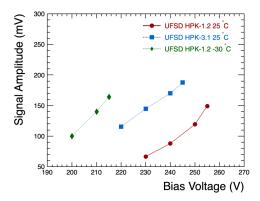


Figure 10: The pulse signal amplitude as a function of bias voltage.

6.3. Noise and Jitter

The noise at different bias voltages is shown in figure 11. The noise usually remains stable in the range of 2.5-4.5 mV throughout the beam test. The signal to noise ratio (SNR) increases with bias voltage and subsequently with the sensor's gain.

Figure 12 shows the jitter as a function of bias voltage. It shows that the jitter decreases with increasing bias voltage. The contribution is higher at the beginning and end of the pulse because of lesser steepness of pulse.

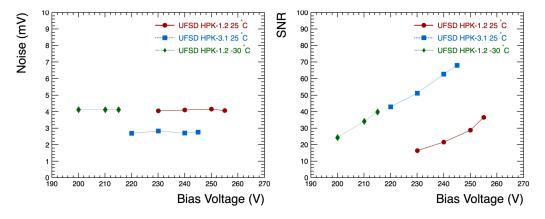


Figure 11: The Noise (left) and Signal-to-Noise Ratio (right) as a function of bias voltage.

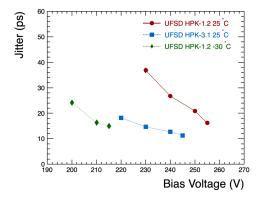


Figure 12: The Jitter as a function of bias voltage.

6.4. Rise Time

The rise-time is a crucial parameter in defining the timing resolution of the UFSD, and it is determined by the drift time of the electrons. The rise-time is the time taken by the signal pulse to reach 90% of maximum signal amplitude from 10%. Figure 13 shows the rise-time at different bias voltages for HPK-1.2 and HPK-3.1. The decreasing trend of the HPK-3.1's rise-time indicates an increase in gain with bias voltage, due to which the drift velocity inside the bulk increases. A similar effect is observed while going from room temperature to low temperature measurements for HPK-1.2. Whereas, for HPK-1.2, the rise-time increases slightly, indicating delay due to the multiplication mechanism at higher gain.

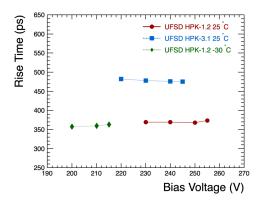


Figure 13: The rise time as a function of the bias voltage.

6.5. Timing Measurements

The timing resolution as a function of the CFD fraction is shown in figure 14. The measured timing resolution is stable above $\sim 15\%$ up-to 80% of CFD fraction. The timing resolution of each of the LGADs described in Section 3.1 has been obtained using the CFD method and shown in figure 15. The results show timing performance at room temperature as well as at -30 °C.

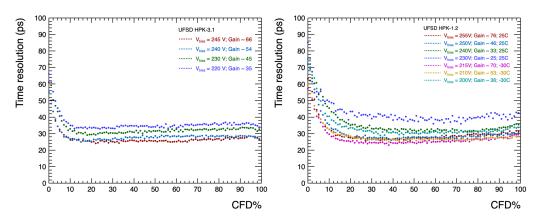


Figure 14: Timing measurement as a function of CFD fraction for HPK-3.1 at room temperature (left) and HPK-1.2 at room temperature and at -30 °C (right).

In the beam test, 3 LGADs are used as DUTs, and 4^{th} LGAD is used as a trigger. The time resolution is calculated for ten sets of DUT combinations. The time differences from different combinations of DUTs and TRG are,

 $\Delta(t_{DUT} - t_{DUT'})$: Three sets of time difference between pairs of DUTs.

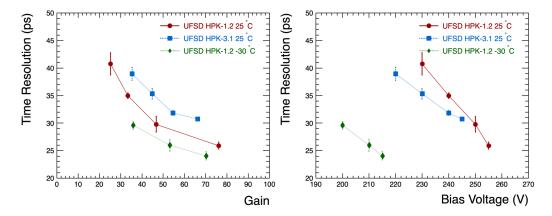


Figure 15: Timing measurement of UFSDs using time-of-flight (TOF) technique for minimum ionising particles (MIP). Timing resolution is shown as a function of gain (left) and bias voltage (right).

 $\Delta(t_{DUT} - t_{TRG})$: Three sets of time difference between DUT and the trigger.

These are the time differences calculated using single DUT, so called as "singlets".

 $\Delta(t_{(\text{2DUT})} - t_{TRG})$: Three sets of time difference between average of pair of DUTs and the trigger. As the time difference is taken for average of two UFSds they are called as "Doublets".

 $\Delta(t_{(3\text{DUT})} - t_{TRG})$: The time difference between average of three DUTs and the trigger gives the "triplet" measurement.

The results for these measurements are shown in figure 16 and tabulated in table 2 for three different operating conditions. It has been seen that results are very well in agreement with the expectation; $\sigma(N) = 1/\sqrt{N}$. The timing resolution of 14.31 \pm 1.52 ps is measured from a triplet of UFSDs operated with a bias voltage of 215 V at -30 °C, which is the fastest reported time resolution for UFSDs to date at the test beam.

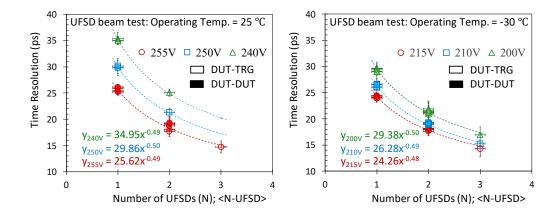


Figure 16: The timing resolutions at different bias voltages as a function of the number of UFSDs combined. The data reports measurements for the HPK-1.2 at room temperature (left) and -30 °C (enclosure air temperature) (right) with a 120 GeV proton beam at the Fermilab Test Beam Facility. The missing data point (for $V_{bias} = 240 \text{ V}$ and 250 V for N = 3 at 25 °C) is due to the failure of power supply to DAQ during the test beam run.

Table 2: The timing resolution for sets of UFSDs; a single (N=1), a pair (N=2), and the triplet (N=3). The data reports measurements for the HPK-1.2 with a 120 GeV proton beam at the Fermilab Test Beam Facility. The missing data point (for $V_{bias}=240V$ and N=3) is due to the failure of power supply to DAQ during the test beam run.

	UFSD Timing Resolution (ps)				
Number of DUTs	$V_{\rm bias} = 240 \text{ V}$	$V_{\rm bias} = 255 \ V$	$V_{\rm bias} = 215 \text{ V}$		
	$(T = 25 ^{\circ}C)$	$(T = 25 ^{\circ}C)$	$(T = -30 ^{\circ}C)$		
N = 1	35.12 ± 1.03	25.63 ± 0.52	24.22 ± 0.72		
N = 2	25.05 ± 0.69	18.67 ± 1.15	18.01 ± 0.94		
N = 3	-	14.73 ± 1.17	14.31 ± 1.52		

7. Conclusions

The UFSDs are tested for timing resolution with the 120 GeV proton test beam at the Fermilab Test Beam Facility. The single LGAD sensor with 35 μ m thickness and active area of 1.3×1.3 mm² provided a timing resolution of 35.12 ± 1.03 ps and 25.63 ± 0.52 ps at 240 V and 255 V respectively at room temperature. The same LGAD sensor's timing performance is improved to 24.22 ± 0.72 ps when operated at -30 °C. In the test beam, a telescope comprising four UFSD planes (3 DUTs and 1 Trigger) is tested

successfully demonstrating improvement on timing resolution given by the relation $1/\sqrt{N}$, where N is the number of UFSDs. When three planes are averaged (triplet), the timing performance of about 14.31 ± 1.52 ps is measured at a reverse bias voltage of 215 V and at temperature -30 °C, which is the fastest reported timing performance to date. It is observed that the targeted timing response of 10 ps is achievable with an optimized number of layers and thickness of LGAD sensors.

8. Acknowledgements

The work is supported by Laboratory Directed Research and Development (LDRD) funding from Argonne National Laboratory, provided by the Director, Office of Science, of the U.S. Department of Energy under Contract No. DE-AC02-06CH11357. The LDRD project name is "Tomography at an Electron-Ion Collider: Unraveling the Origin of Mass and Spin". Argonne National Laboratory's work is supported by the U.S. Department of Energy, Office of Science, Office of Nuclear Physics, Office of High Energy Physics, under contract DE-AC02-06CH11357. This work is also supported by the United States Department of Energy, grant DE-FG02-04ER41286.

This document is prepared using the resources of the Fermi National Accelerator Laboratory (Fermilab), a U.S. Department of Energy, Office of Science, Fermi Lab Test Beam Facility. Fermilab is managed by Fermi Research Alliance, LLC (FRA), acting under Contract No. DE-AC02-07CH11359.

We are thankful to Thomas O'Connor and his team at Physics Division, Argonne National Laboratory for their help in fabricating the alignment box. We also like to acknowledge the help provided by Michelle Jonas and Humberto Gonzalez at Silicon Detector Facility, Fermilab in wire-bonding LGAD sensors onto the read-out boards.

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